PCN Number: 2019		20190107003	0190107003.0 PCN Date:		January 23, 2019				
Title: Datasheet for TMP112									
Customer Contact: PCN		CN Manager	Manager		Dept	:	Quality Services		
Ch	ange Type:								
	Assembly Site		Design			Nafe	r Bump Site		
Assembly Process						Wafer Bump Material			
Assembly Materials		_	Part number change			Wafer Bump Process			
Mechanical Specification			Test Site			Wafer Fab Site			
Packing/Shipping/Labeli		ibeling	Test Process			Wafer Fab Materials Wafer Fab Process			
		N	atificatio	n Dotoile		ware	r Fab Process		
Notification Details Poscription of Change:									
Description of Change: Texas Instruments Incorporated is announcing an information only notification.									
The product datasheet(s) is being updated as summarized below.									
The following change history provides further details.									
TEXAS TMP112									
	INSTRUMENTS SBOS473I – MARCH 2009 – REVISED DECEMBER 2018								
Changes from Revision H (October 2018) to Revision I Page									
Changed input voltage maximum to voltage maximum for SCL, ADD0 and SDA pins									
Deleted Absolute Maximum Ratings for output voltage and replaced with pin level information									
Added voltage at ALERT pin Absolute Maximum Ratings									
The datasheet number will be changing.									
D	evice Family				Change From:		Change To:		
	TMP112				SBOS473H		SBOS473I		
These changes may be reviewed at the datasheet links provided.									
http://www.ti.com/product/TMP112									
Reason for Change:									
To accurately reflect device characteristics.									
Anticipated impact on Fit, Form, Function, Quality or Reliability (positive / negative):									
No anticipated impact. This is a specification change announcement only. There are no changes to									
the actual device.									
Changes to product identification resulting from this PCN:									
None.									
Product Affected:									
ΙΤ	MP112AIDRLR	TMP112AIDI	RLT	TMP112BIDR	LR	Т	MP112BIDRLT		
TI	MP112NAIDRLR	TMP112NAII	ORLT						
		I							

For questions regarding this notice, e-mails can be sent to the regional contacts shown below or your local Field Sales Representative.

Location	E-Mail
USA	PCNAmericasContact@list.ti.com
Europe	PCNEuropeContact@list.ti.com
Asia Pacific	PCNAsiaContact@list.ti.com
Japan	PCNJapanContact@list.ti.com